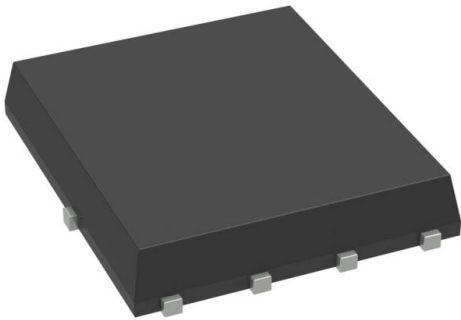


FDMS86252 Datasheet

www.digi-electronics.com



<https://www.DiGi-Electronics.com>

| | |
|------------------------------|--|
| DiGi Electronics Part Number | FDMS86252-DG |
| Manufacturer | onsemi |
| Manufacturer Product Number | FDMS86252 |
| Description | MOSFET N-CH 150V 4.6A/16A 8PQFN |
| Detailed Description | N-Channel 150 V 4.6A (Ta), 16A (Tc) 2.5W (Ta), 69W (Tc) Surface Mount 8-PQFN (5x6) |



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

FDMS86252

Series:

PowerTrench®

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

150 V

Drive Voltage (Max Rds On, Min Rds On):

6V, 10V

Vgs(th) (Max) @ Id:

4V @ 250µA

Vgs (Max):

±20V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

8-PQFN (5x6)

Base Product Number:

FDMS86

Manufacturer:

onsemi

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

4.6A (Ta), 16A (Tc)

Rds On (Max) @ Id, Vgs:

51mOhm @ 4.6A, 10V

Gate Charge (Qg) (Max) @ Vgs:

15 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

905 pF @ 75 V

Power Dissipation (Max):

2.5W (Ta), 69W (Tc)

Mounting Type:

Surface Mount

Package / Case:

8-PowerTDFN

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



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October 2014

FDMS86252

N-Channel Shielded Gate PowerTrench[®] MOSFET

150 V, 16 A, 51 mΩ

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 51 mΩ at $V_{GS} = 10$ V, $I_D = 4.6$ A
- Max $r_{DS(on)}$ = 70 mΩ at $V_{GS} = 6$ V, $I_D = 3.9$ A
- Advanced package and silicon combination for low $r_{DS(on)}$ and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

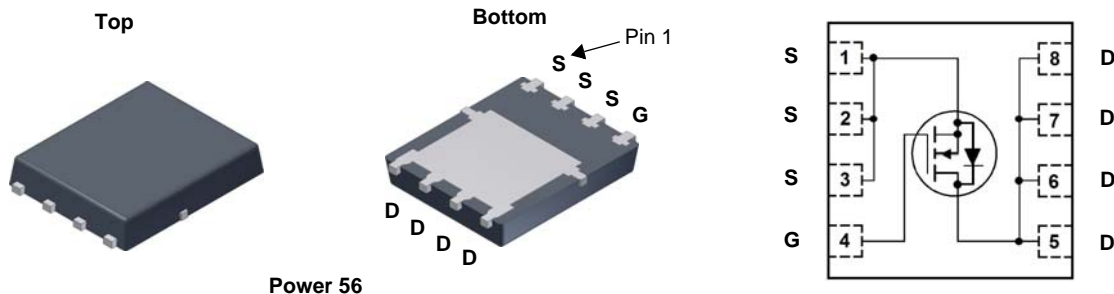


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

- DC-DC Conversion



Power 56

MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

| Symbol | Parameter | Ratings | Units |
|----------------|--|-------------------------|-------|
| V_{DS} | Drain to Source Voltage | 150 | V |
| V_{GS} | Gate to Source Voltage | ±20 | V |
| I_D | Drain Current -Continuous | $T_C = 25$ °C | 16 |
| | -Continuous | $T_A = 25$ °C (Note 1a) | 4.6 |
| | -Pulsed | | 20 |
| E_{AS} | Single Pulse Avalanche Energy | (Note 3) | 50 |
| P_D | Power Dissipation | $T_C = 25$ °C | 69 |
| | Power Dissipation | $T_A = 25$ °C (Note 1a) | 2.5 |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | -55 to +150 | °C |

Thermal Characteristics

| | | | |
|-----------------|---|-----|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 1.8 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (Note 1a) | 50 | |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|-----------|----------|-----------|------------|------------|
| FDMS86252 | FDMS86252 | Power 56 | 13" | 12 mm | 3000 units |

Electrical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|--------|-----------|-----------------|-----|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-----|-------|

Off Characteristics

| | | | | | | |
|--------------------------------------|---|---|-----|-----|-----------|----------------------|
| BV_{DSS} | Drain to Source Breakdown Voltage | $I_D = 250\text{ }\mu\text{A}, V_{GS} = 0\text{ V}$ | 150 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^\circ\text{C}$ | | 106 | | mV/ $^\circ\text{C}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 120\text{ V}, V_{GS} = 0\text{ V}$ | | | 1 | μA |
| I_{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$ | | | ± 100 | nA |

On Characteristics

| | | | | | | |
|--|--|---|-----|------|-----|----------------------|
| $V_{GS(th)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250\text{ }\mu\text{A}$ | 2.0 | 2.8 | 4.0 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^\circ\text{C}$ | | -9 | | mV/ $^\circ\text{C}$ |
| $r_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10\text{ V}, I_D = 4.6\text{ A}$ | | 43.9 | 51 | m Ω |
| | | $V_{GS} = 6\text{ V}, I_D = 3.9\text{ A}$ | | 50.5 | 70 | |
| | | $V_{GS} = 10\text{ V}, I_D = 4.6\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | | 83 | 96 | |
| g_{FS} | Forward Transconductance | $V_{DS} = 10\text{ V}, I_D = 4.6\text{ A}$ | | 15 | | S |

Dynamic Characteristics

| | | | | | | |
|-----------|------------------------------|---|-----|-----|-----|----------|
| C_{iss} | Input Capacitance | $V_{DS} = 75\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | | 678 | 905 | pF |
| C_{oss} | Output Capacitance | | | 74 | 115 | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 4.3 | 10 | pF |
| R_g | Gate Resistance | | 0.1 | 0.4 | 1.8 | Ω |

Switching Characteristics

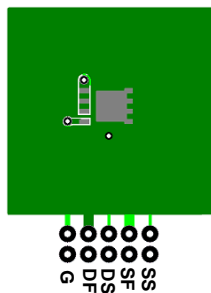
| | | | | | | | |
|--------------|-------------------------------|---|--|-----|-----|-----|----|
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD} = 75\text{ V}, I_D = 4.6\text{ A}, V_{GS} = 10\text{ V}, R_{GEN} = 6\text{ }\Omega$ | | 7.7 | 16 | ns | |
| t_r | Rise Time | | | 2.3 | 10 | ns | |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 15 | 27 | ns | |
| t_f | Fall Time | | | 3.2 | 10 | ns | |
| Q_g | Total Gate Charge | | $V_{GS} = 0\text{ V to } 10\text{ V}$ | | 11 | 15 | nC |
| Q_g | Total Gate Charge | $V_{GS} = 0\text{ V to } 5\text{ V}$ | $V_{DD} = 75\text{ V}, I_D = 4.6\text{ A}$ | | 6.1 | 8.6 | nC |
| Q_{gs} | Gate to Source Charge | | | | 2.8 | | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | | | 2.4 | | nC |

Drain-Source Diode Characteristics

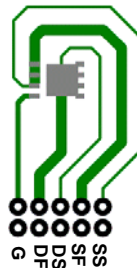
| | | | | | | |
|----------|------------------------------------|--|--|------|-----|----|
| V_{SD} | Source-Drain Diode Forward Voltage | $V_{GS} = 0\text{ V}, I_S = 2\text{ A}$ (Note 2) | | 0.75 | 1.2 | V |
| | | $V_{GS} = 0\text{ V}, I_S = 4.6\text{ A}$ (Note 2) | | 0.80 | 1.3 | |
| t_{rr} | Reverse Recovery Time | $I_F = 4.6\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$ | | 56 | 90 | ns |
| Q_{rr} | Reverse Recovery Charge | | | 61 | 98 | nC |

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 50 $^\circ\text{C}/\text{W}$ when mounted on a 1 in² pad of 2 oz copper.



b. 125 $^\circ\text{C}/\text{W}$ when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.

3. Starting $T_J = 25\text{ }^\circ\text{C}$, $L = 1\text{ mH}$, $I_{AS} = 10\text{ A}$, $V_{DD} = 135\text{ V}$, $V_{GS} = 10\text{ V}$.

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

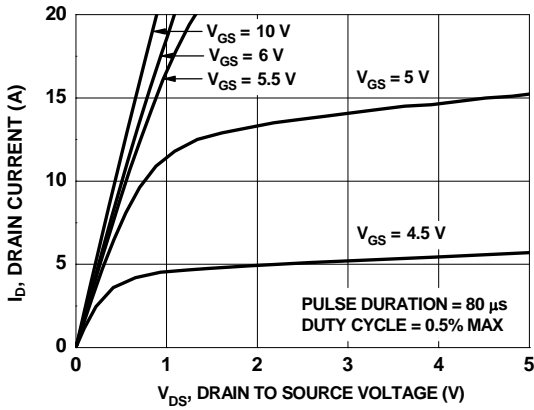


Figure 1. On Region Characteristics

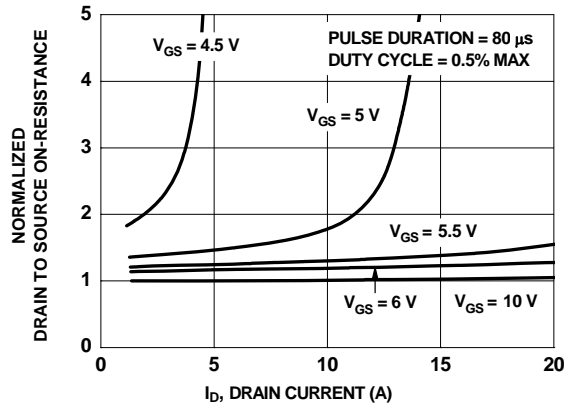


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

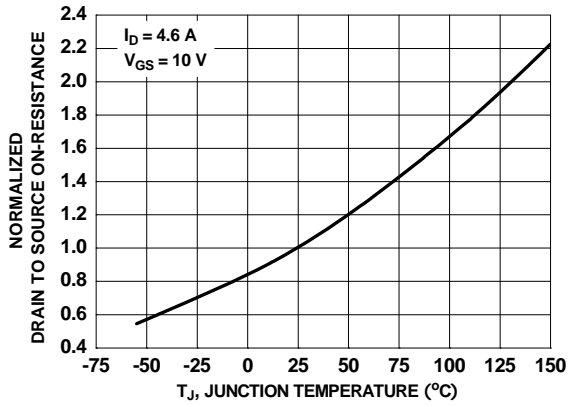


Figure 3. Normalized On Resistance vs Junction Temperature

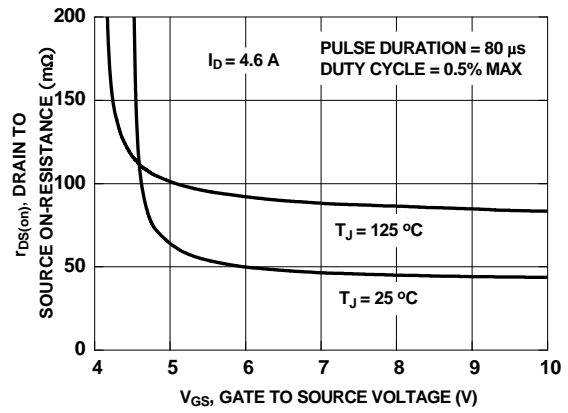


Figure 4. On-Resistance vs Gate to Source Voltage

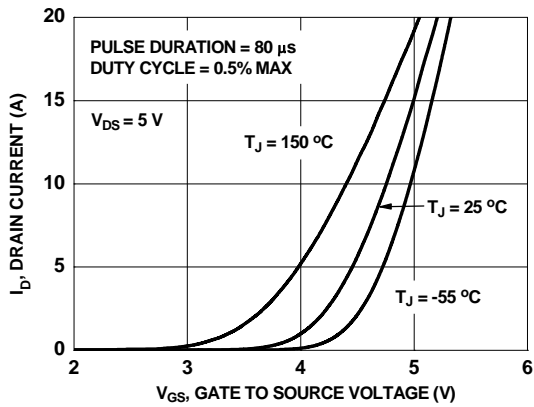


Figure 5. Transfer Characteristics

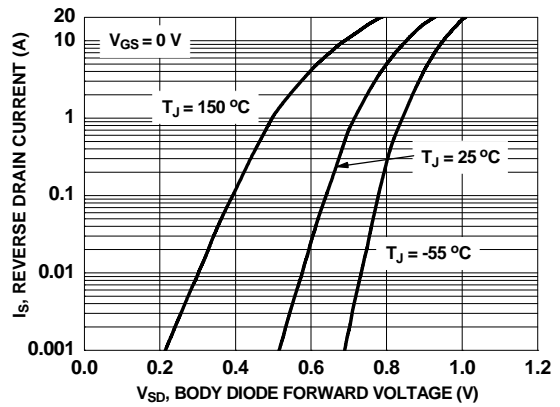


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

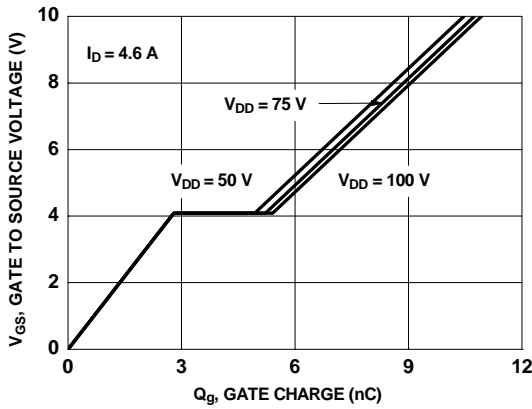


Figure 7. Gate Charge Characteristics

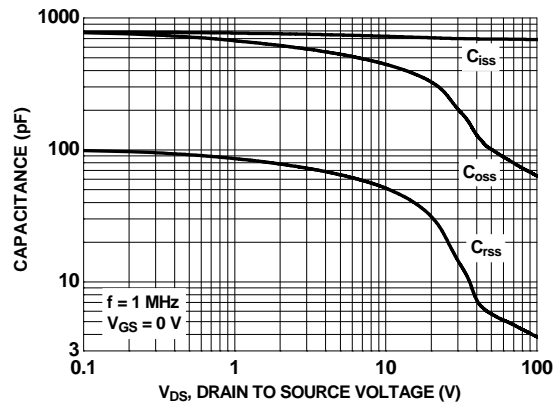


Figure 8. Capacitance vs Drain to Source Voltage

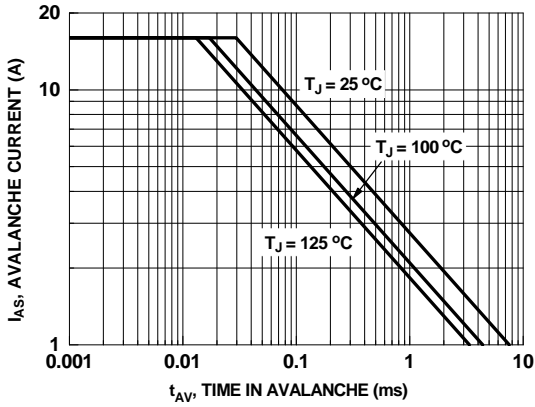


Figure 9. Unclamped Inductive Switching Capability

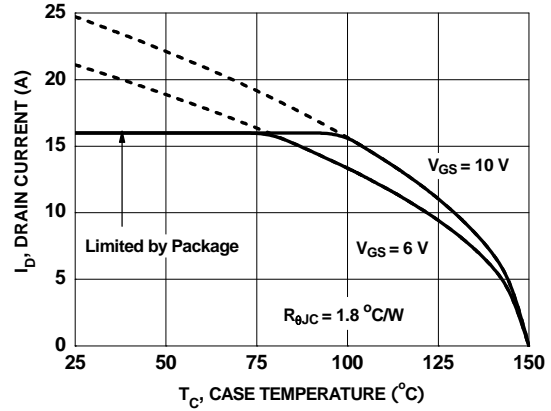


Figure 10. Maximum Continuous Drain Current vs Case Temperature

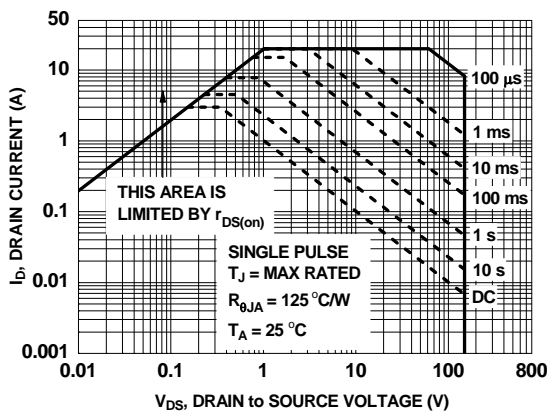


Figure 11. Forward Bias Safe Operating Area

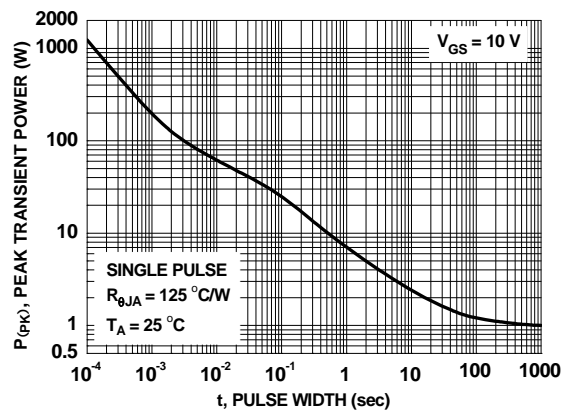


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

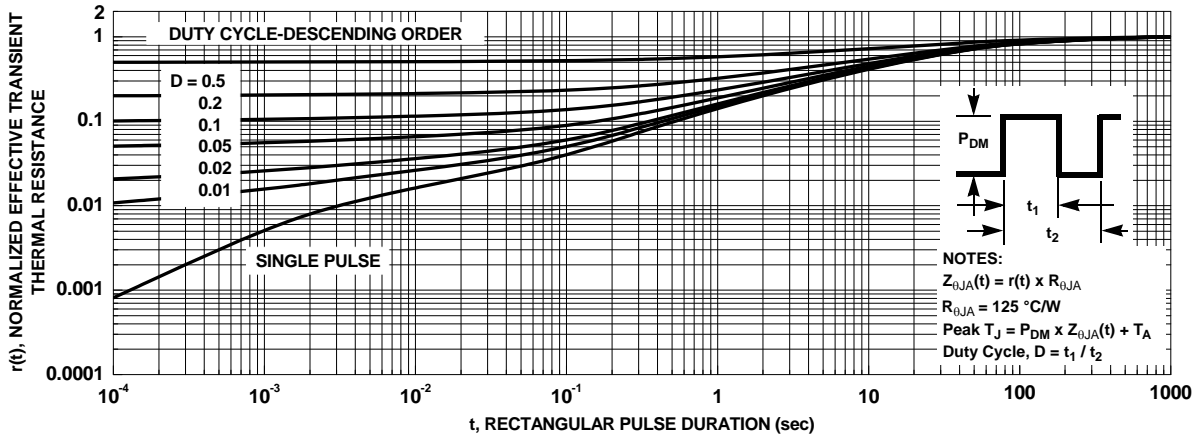
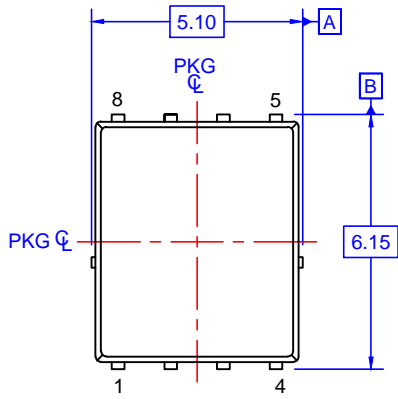
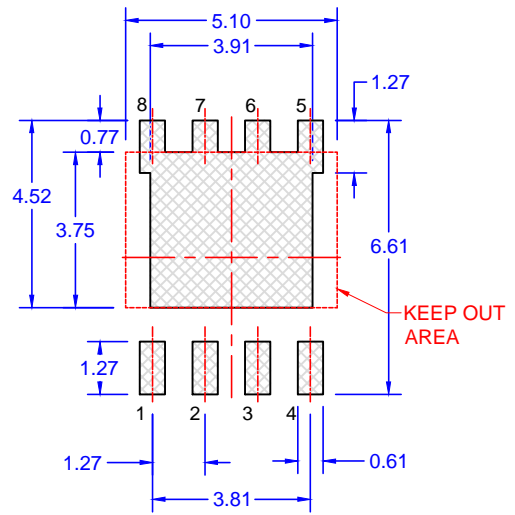
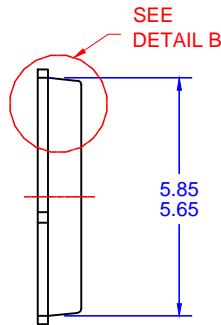


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

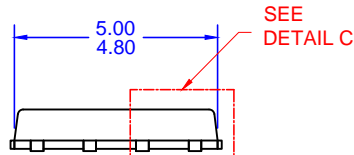
PQFN8 5X6, 1.27P
CASE 483AE
ISSUE A



TOP VIEW

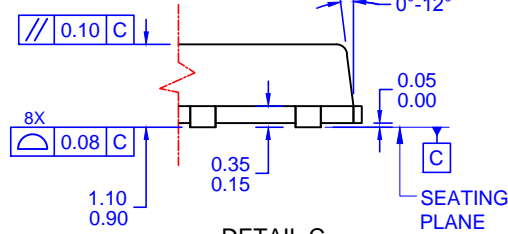


LAND PATTERN RECOMMENDATION

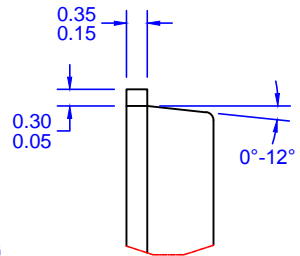


SIDE VIEW

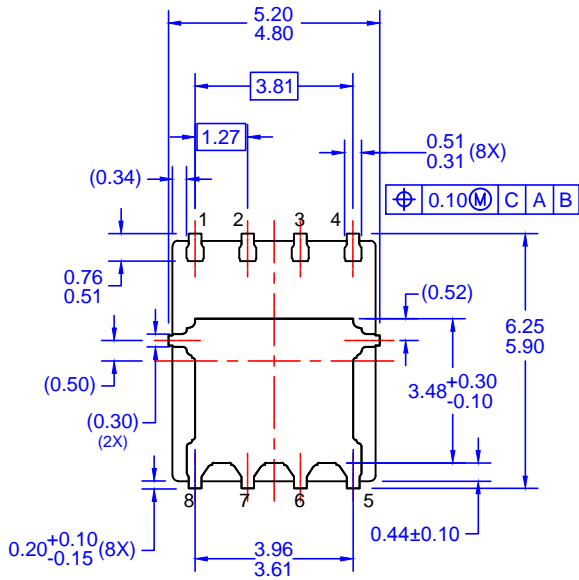
OPTIONAL DRAFT ANGLE MAY APPEAR ON FOUR SIDES OF THE PACKAGE



DETAIL C
SCALE: 2:1



DETAIL B
SCALE: 2:1




BOTTOM VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

- A. PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. AA.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- E. IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.

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